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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	18
Program Memory Size	16KB (5.5K x 24)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24f16kl401-i-so

TABLE 1-3: DEVICE FEATURES FOR THE PIC24F16KL20X/10X DEVICES

Features	PIC24F08KL201	PIC24F04KL101	PIC24F08KL200	PIC24F04KL100
Operating Frequency	DC – 32 MHz			
Program Memory (bytes)	8K	4K	8K	4K
Program Memory (instructions)	2816	1408	2816	1408
Data Memory (bytes)	512	512	512	512
Data EEPROM Memory (bytes)	—	—	—	—
Interrupt Sources (soft vectors/NMI traps)	27 (23/4)	26 (22/4)	27 (23/4)	26 (22/4)
I/O Ports	PORTA<6:0> PORTB<15:12,9:7,4,2:0>		PORTA<5:0> PORTB<15:14,9:8,4,0>	
Total I/O Pins	17		12	
Timers (8/16-bit)	1/2	1/2	1/2	1/2
Capture/Compare/PWM modules:				
Total	2	2	2	2
Enhanced CCP	0	0	0	0
Input Change Notification Interrupt	17	17	11	11
Serial Communications:				
UART	1	1	1	1
MSSP	1	1	1	1
10-Bit Analog-to-Digital Module (input channels)	12	—	7	—
Analog Comparators	1	1	1	1
Resets (and delays)	POR, BOR, RESET Instruction, $\overline{\text{MCLR}}$, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (PWRT, OST, PLL Lock)			
Instruction Set	76 Base Instructions, Multiple Addressing Mode Variations			
Packages	20-Pin PDIP/SSOP/SOIC/QFN		14-Pin PDIP/TSSOP	

For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- *AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC™ and PICmicro® Devices"*
- *AN849, "Basic PICmicro® Oscillator Design"*
- *AN943, "Practical PICmicro® Oscillator Analysis and Design"*
- *AN949, "Making Your Oscillator Work"*

2.6 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 kΩ to 10 kΩ resistor to VSS on unused pins and drive the output to logic low.

FIGURE 3-2: PROGRAMMER'S MODEL

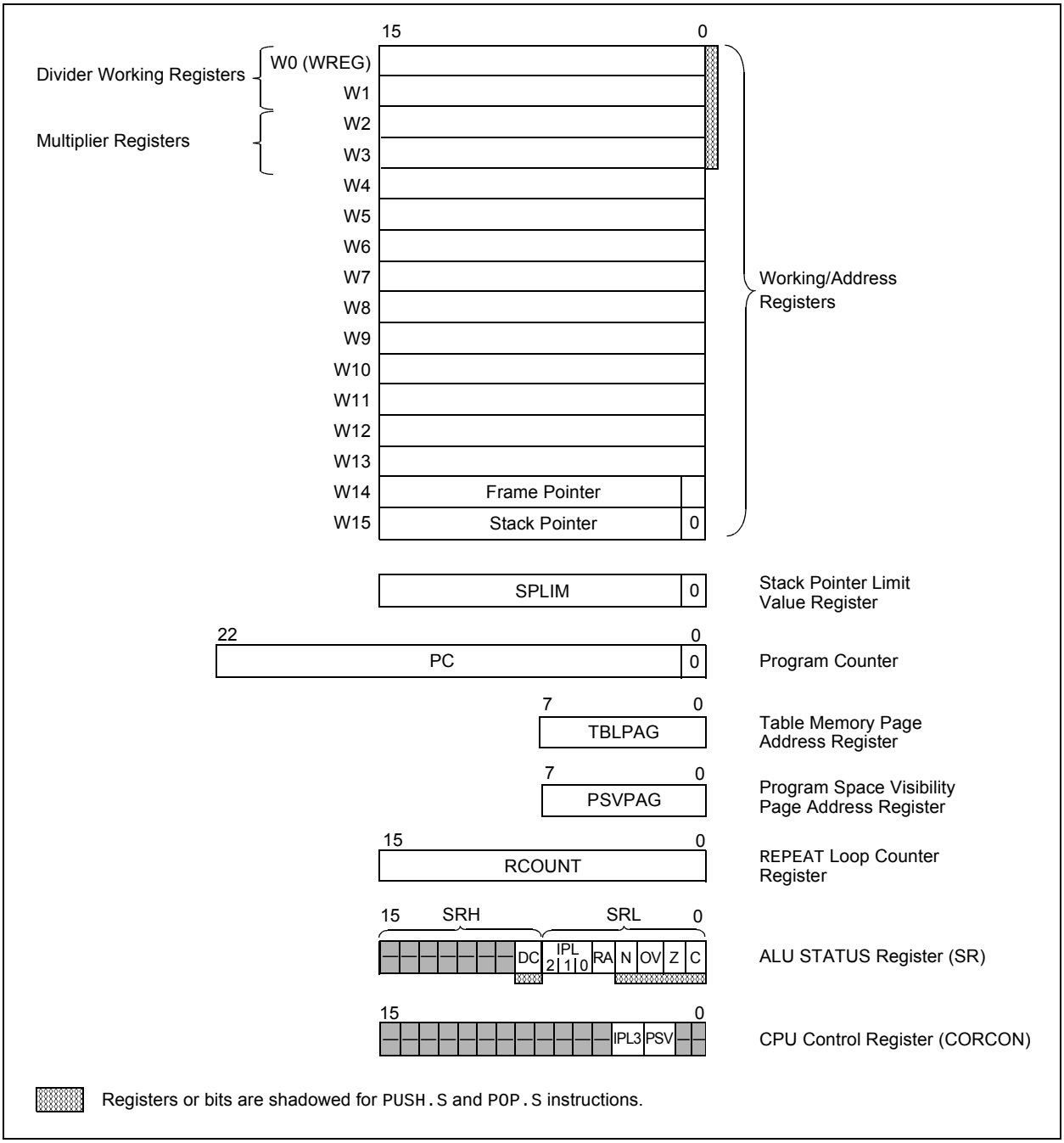


TABLE 4-6: TIMER REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TMR1	0100	Timer1 Register																0000
PR1	0102	Timer1 Period Register																FFFF
T1CON	0104	TON	—	TSIDL	—	—	—	T1ECS1	T1ECS0	—	TGATE	TCKPS1	TCKPS0	—	TSYNC	TCS	—	0000
TMR2	0106	—	—	—	—	—	—	—	—	Timer2 Register								0000
PR2	0108	—	—	—	—	—	—	—	—	Timer2 Period Register								00FF
T2CON	010A	—	—	—	—	—	—	—	—	—	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	0000
TMR3	010C	Timer3 Register																0000
T3GCON	010E	—	—	—	—	—	—	—	—	TMR3GE	T3GPOL	T3GTM	T3GSPM	T3GGO/$\overline{\text{T3DONE}}$	T3GVAL	T3GSS1	T3GSS0	0000
T3CON	0110	—	—	—	—	—	—	—	—	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	T3OSCEN	$\overline{\text{T3SYNC}}$	—	TMR3ON	0000
TMR4(1)	0112	—	—	—	—	—	—	—	—	Timer4 Register								0000
PR4(1)	0114	—	—	—	—	—	—	—	—	Timer4 Period Register								00FF
T4CON(1)	0116	—	—	—	—	—	—	—	—	—	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	0000
CCPTMRS0(1)	013C	—	—	—	—	—	—	—	—	—	C3TSEL0(1)	—	—	C2TSEL0	—	—	C1TSEL0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits and/or registers are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

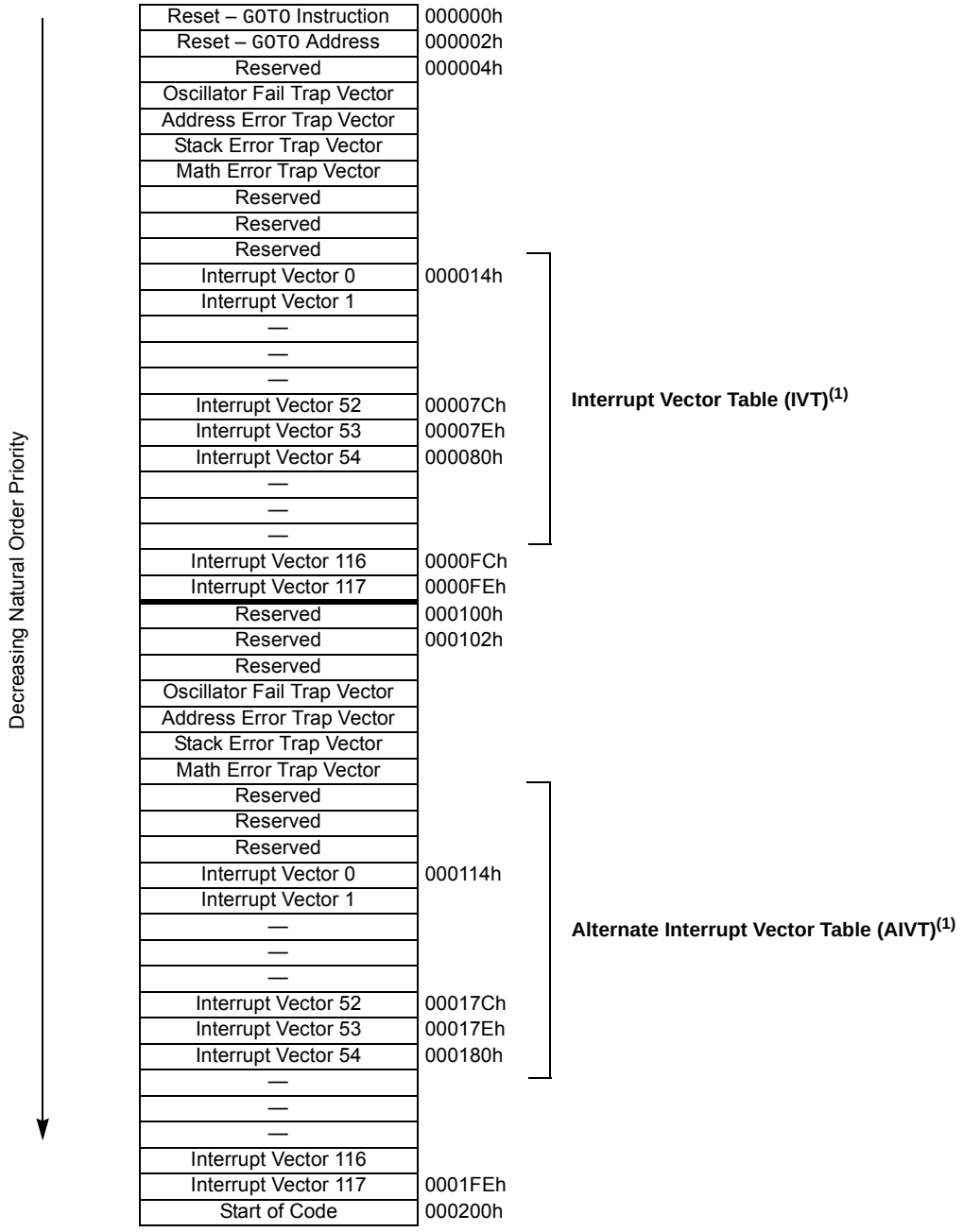
TABLE 4-7: CCP/ECCP REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CCP1CON	0190	—	—	—	—	—	—	—	—	PM1(1)	PM0(1)	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0000
CCPR1L	0192	—	—	—	—	—	—	—	—	Capture/Compare/PWM1 Register Low Byte								0000
CCPR1H	0194	—	—	—	—	—	—	—	—	Capture/Compare/PWM1 Register High Byte								0000
ECCP1DEL(1)	0196	—	—	—	—	—	—	—	—	PRSEN	PDC6	PDC5	PDC4	PDC3	PDC2	PDC1	PDC0	0000
ECCP1AS(1)	0198	—	—	—	—	—	—	—	—	ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1	PSSBD0	0000
PSTR1CON(1)	019A	—	—	—	—	—	—	—	—	CMPL1	CMPL0	—	STRSYNC	STRD	STRC	STRB	STRA	0001
CCP2CON	019C	—	—	—	—	—	—	—	—	—	—	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	0000
CCPR2L	019E	—	—	—	—	—	—	—	—	Capture/Compare/PWM2 Register Low Byte								0000
CCPR2H	01A0	—	—	—	—	—	—	—	—	Capture/Compare/PWM2 Register High Byte								0000
CCP3CON(1)	01A8	—	—	—	—	—	—	—	—	—	—	DC3B1	DC3B0	CCP3M3	CCP3M2	CCP3M1	CCP3M0	0000
CCPR3L(1)	01AA	—	—	—	—	—	—	—	—	Capture/Compare/PWM3 Register Low Byte								0000
CCPR3H(1)	01AC	—	—	—	—	—	—	—	—	Capture/Compare/PWM3 Register High Byte								0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits and/or registers are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

FIGURE 8-1: PIC24F INTERRUPT VECTOR TABLE



Note 1: See Table 8-2 for the interrupt vector list.

REGISTER 8-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
NSTDIS	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
—	—	—	MATHERR	ADDRERR	STKERR	OSCFAIL	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **NSTDIS:** Interrupt Nesting Disable bit
1 = Interrupt nesting is disabled
0 = Interrupt nesting is enabled

bit 14-5 **Unimplemented:** Read as ‘0’

bit 4 **MATHERR:** Arithmetic Error Trap Status bit
1 = Overflow trap has occurred
0 = Overflow trap has not occurred

bit 3 **ADDRERR:** Address Error Trap Status bit
1 = Address error trap has occurred
0 = Address error trap has not occurred

bit 2 **STKERR:** Stack Error Trap Status bit
1 = Stack error trap has occurred
0 = Stack error trap has not occurred

bit 1 **OSCFAIL:** Oscillator Failure Trap Status bit
1 = Oscillator failure trap has occurred
0 = Oscillator failure trap has not occurred

bit 0 **Unimplemented:** Read as ‘0’

REGISTER 8-20: IPC3: INTERRUPT PRIORITY CONTROL REGISTER 3

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	NVMIP2	NVMIP1	NVMIP0	—	—	—	—
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	AD1IP2	AD1IP1	AD1IP0	—	U1TXIP2	U1TXIP1	U1TXIP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **NVMIP<2:0>:** NVM Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11-7 **Unimplemented:** Read as ‘0’

bit 6-4 **AD1IP<2:0>:** A/D Conversion Complete Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **U1TXIP<2:0>:** UART1 Transmitter Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

REGISTER 8-30: INTTREG: INTERRUPT CONTROL AND STATUS REGISTER

R-0	r-0	R/W-0	U-0	R-0	R-0	R-0	R-0
CPUIRQ	r	VHOLD	—	ILR3	ILR2	ILR1	ILR0
bit 15							bit 8

U-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
—	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0
bit 7							bit 0

Legend:	r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CPUIRQ:** Interrupt Request from Interrupt Controller CPU bit
1 = An interrupt request has occurred but has not yet been Acknowledged by the CPU (this will happen when the CPU priority is higher than the interrupt priority)
0 = No interrupt request is left unacknowledged

bit 14 **Reserved:** Maintain as '0'

bit 13 **VHOLD:** Vector Hold bit
Allows Vector Number Capture and Changes What Interrupt is Stored in the VECNUM bit:
1 = VECNUM<6:0> will contain the value of the highest priority pending interrupt, instead of the current interrupt
0 = VECNUM<6:0> will contain the value of the last Acknowledged interrupt (last interrupt that has occurred with higher priority than the CPU, even if other interrupts are pending)

bit 12 **Unimplemented:** Read as '0'

bit 11-8 **ILR<3:0>:** New CPU Interrupt Priority Level bits
1111 = CPU Interrupt Priority Level is 15
•
•
•
0001 = CPU Interrupt Priority Level is 1
0000 = CPU Interrupt Priority Level is 0

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **VECNUM<6:0>:** Vector Number of Pending Interrupt bits
0111111 = Interrupt vector pending is Number 135
•
•
•
0000001 = Interrupt vector pending is Number 9
0000000 = Interrupt vector pending is Number 8

NOTES:

REGISTER 12-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
TON	—	TSIDL	—	—	—	T1ECS1(1)	T1ECS0(1)
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
—	TGATE	TCKPS1	TCKPS0	—	TSYNC	TCS	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **TON:** Timer1 On bit
1 = Starts 16-bit Timer1
0 = Stops 16-bit Timer1

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Timer1 Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-10 **Unimplemented:** Read as '0'

bit 9-8 **T1ECS <1:0>:** Timer1 Extended Clock Select bits(1)
11 = Reserved; do not use
10 = Timer1 uses the LPRC as the clock source
01 = Timer1 uses the external clock from T1CK
00 = Timer1 uses the Secondary Oscillator (SOSC) as the clock source

bit 7 **Unimplemented:** Read as '0'

bit 6 **TGATE:** Timer1 Gated Time Accumulation Enable bit
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>:** Timer1 Input Clock Prescale Select bits
11 = 1:256
10 = 1:64
01 = 1:8
00 = 1:1

bit 3 **Unimplemented:** Read as '0'

bit 2 **TSYNC:** Timer1 External Clock Input Synchronization Select bit
When TCS = 1:
1 = Synchronizes external clock input
0 = Does not synchronize external clock input
When TCS = 0:
This bit is ignored.

bit 1 **TCS:** Timer1 Clock Source Select bit
1 = Timer1 clock source is selected by T1ECS<1:0>
0 = Internal clock (FOSC/2)

bit 0 **Unimplemented:** Read as '0'

Note 1: The T1ECSx bits are valid only when TCS = 1.

REGISTER 13-1: T2CON: TIMER2 CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-3 **T2OUTPS<3:0>:** Timer2 Output Postscale Select bits
1111 = 1:16 Postscale
1110 = 1:15 Postscale
•
•
•
0001 = 1:2 Postscale
0000 = 1:1 Postscale

bit 2 **TMR2ON:** Timer2 On bit
1 = Timer2 is on
0 = Timer2 is off

bit 1-0 **T2CKPS<1:0>:** Timer2 Clock Prescale Select bits
10 = Prescaler is 16
01 = Prescaler is 4
00 = Prescaler is 1

14.0 TIMER3 MODULE

Note:	This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Timers, refer to the *"dsPIC33/PIC24 Family Reference Manual"*, **"Timers"** (DS39704).

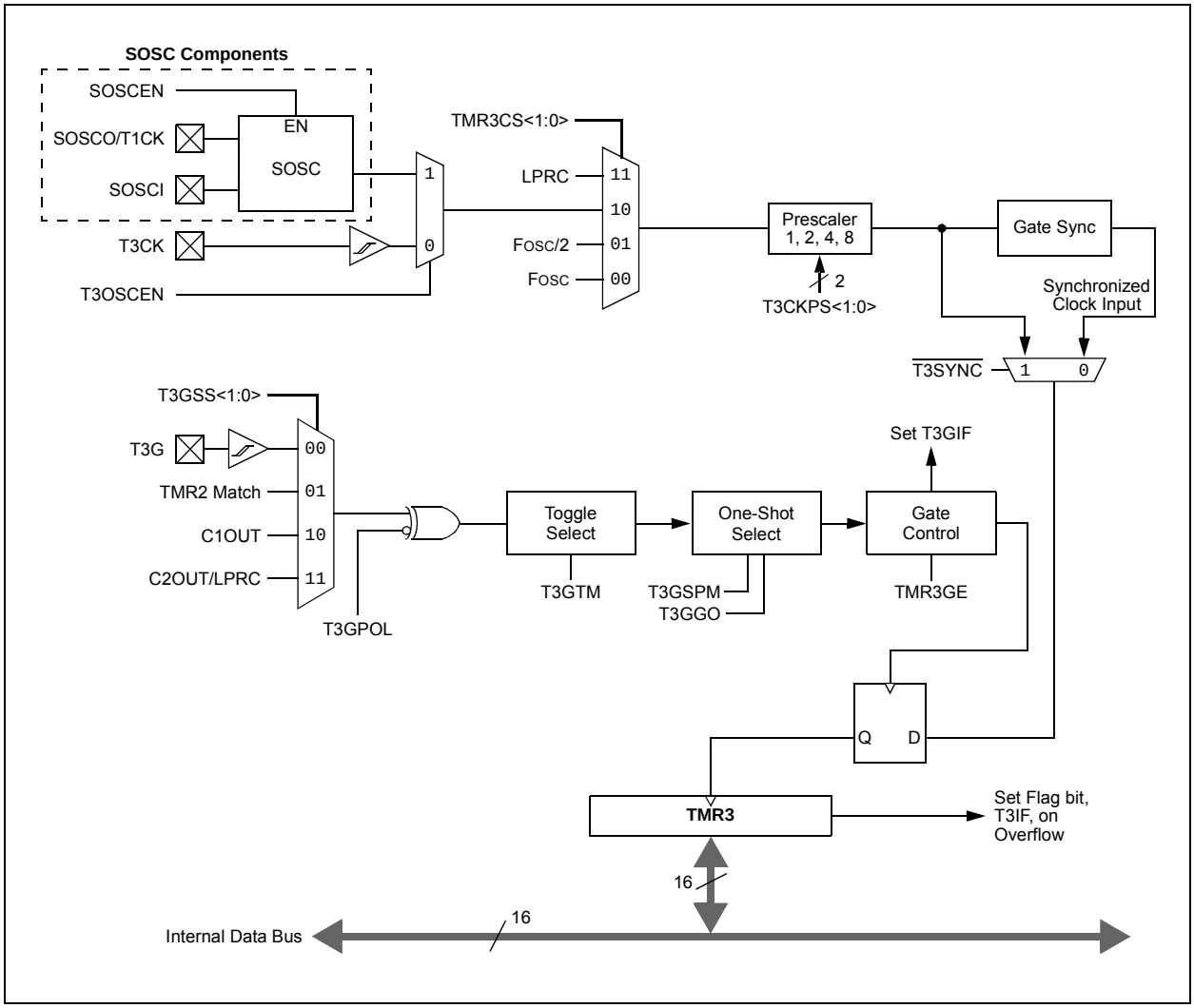
The Timer3 timer/counter modules incorporate these features:

- Software-selectable operation as a 16-bit timer or counter
- One 16-bit readable and writable Timer Value register
- Selectable clock source (internal or external) with device clock, SOSC or LPRC oscillator options
- Interrupt-on-overflow
- Multiple timer gating options, including:
  - User-selectable gate sources and polarity
  - Gate/toggle operation
  - Single Pulse (One-Shot) mode
- Module Reset on ECCP Special Event Trigger

The Timer3 module is controlled through the T3CON register (Register 14-1). A simplified block diagram of the Timer3 module is shown in Figure 14-1.

The FOSC clock source should not be used with the ECCP capture/compare features. If the timer will be used with the capture or compare features, always select one of the other timer clocking options.

FIGURE 14-1: TIMER3 BLOCK DIAGRAM



REGISTER 17-7: SSPxCON3: MSSPx CONTROL REGISTER 3 (I^2C™ MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ACKTIM(2)	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 **ACKTIM:** Acknowledge Time Status bit(2)
1 = Indicates the I^2C bus is in an Acknowledge sequence, set on the 8th falling edge of the SCLx clock
0 = Not an Acknowledge sequence, cleared on the 9th rising edge of the SCLx clock

bit 6 **PCIE**: Stop Condition Interrupt Enable bit
1 = Enables interrupt on detection of a Stop condition
0 = Stop detection interrupts are disabled(1)

bit 5 **SCIE**: Start Condition Interrupt Enable bit
1 = Enables interrupt on detection of the Start or Restart conditions
0 = Start detection interrupts are disabled(1)

bit 4 **BOEN:** Buffer Overwrite Enable bit
I^2C Master mode:
This bit is ignored.
I^2C Slave mode:
1 = SSPxBUF is updated and an $\overline{ACK}$ is generated for a received address/data byte, ignoring the state of the SSPOV bit only if the BF bit = 0
0 = SSPxBUF is only updated when SSPOV is clear

bit 3 **SDAHT:** SDAx Hold Time Selection bit
1 = Minimum of 300 ns hold time on SDAx after the falling edge of SCLx
0 = Minimum of 100 ns hold time on SDAx after the falling edge of SCLx

bit 2 **SBCDE:** Slave Mode Bus Collision Detect Enable bit (Slave mode only)
1 = Enables slave bus collision interrupts
0 = Slave bus collision interrupts are disabled

bit 1 **AHEN:** Address Hold Enable bit (Slave mode only)
1 = Following the 8th falling edge of SCLx for a matching received address byte; the CKP bit of the SSPxCON1 register will be cleared and SCLx will be held low
0 = Address holding is disabled

bit 0 **DHEN:** Data Hold Enable bit (Slave mode only)
1 = Following the 8th falling edge of SCLx for a received data byte; slave hardware clears the CKP bit of the SSPxCON1 register and SCLx is held low
0 = Data holding is disabled

Note 1: This bit has no effect in Slave modes for which Start and Stop condition detection is explicitly listed as enabled.

2: The ACKTIM status bit is active only when the AHEN bit or DHEN bit is set.

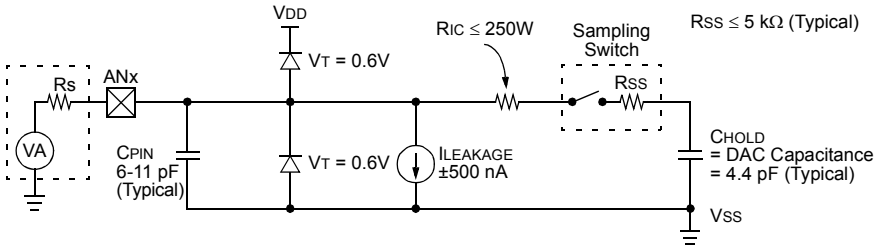
EQUATION 19-1: A/D CONVERSION CLOCK PERIOD(1)

$$ADCS = \frac{TAD}{TCY} - 1$$

$$TAD = TCY \bullet (ADCS + 1)$$

Note 1: Based on TCY = 2 * TOSC; Doze mode and PLL are disabled.

FIGURE 19-2: 10-BIT A/D CONVERTER ANALOG INPUT MODEL



Legend:	CPIN	= Input Capacitance
	VT	= Threshold Voltage
	ILEAKAGE	= Leakage Current at the pin due to Various Junctions
	RIC	= Interconnect Resistance
	RSS	= Sampling Switch Resistance
	CHOLD	= Sample/Hold Capacitance (from DAC)

Note: CPIN value depends on device package and is not tested. Effect of CPIN is negligible if Rs ≤ 5 kΩ.

REGISTER 23-4: FOSC: OSCILLATOR CONFIGURATION REGISTER

R/P-0	R/P-0	R/P-1	R/P-1	R/P-1	R/P-0	R/P-1	R/P-1
FCKSM1	FCKSM0	SOSCSEL	POSCFREQ1	POSCFREQ0	OSCIOFNC	POSCMD1	POSCMD0
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **FCKSM<1:0>:** Clock Switching and Monitor Selection Configuration bits
1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled
01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled
00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled

bit 5 **SOSCSEL:** Secondary Oscillator Power Selection Configuration bit
1 = Secondary oscillator is configured for high-power operation
0 = Secondary oscillator is configured for low-power operation

bit 4-3 **POSCFREQ<1:0>:** Primary Oscillator Frequency Range Configuration bits
11 = Primary oscillator/external clock input frequency is greater than 8 MHz
10 = Primary oscillator/external clock input frequency is between 100 kHz and 8 MHz
01 = Primary oscillator/external clock input frequency is less than 100 kHz
00 = Reserved; do not use

bit 2 **OSCIOFNC:** CLKO Enable Configuration bit
1 = CLKO output signal is active on the OSCO pin; primary oscillator must be disabled or configured for the External Clock mode (EC) for the CLKO to be active (POSCMD<1:0> = 11 or 00)
0 = CLKO output is disabled

bit 1-0 **POSCMD<1:0>:** Primary Oscillator Configuration bits
11 = Primary Oscillator mode is disabled
10 = HS Oscillator mode is selected
01 = XT Oscillator mode is selected
00 = External Clock mode is selected

TABLE 26-6: DC CHARACTERISTICS: OPERATING CURRENT (I_{DD})(2)

DC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Conditions**		
IDD Current						
DC20	0.154	0.350	mA	1.8V	+85V°C	0.5 MIPS, FOSC = 1 MHz
	0.301	0.630		3.3V		
	—	.500	mA	1.8V	+125°C	
	—	.800		3.3V		
DC22	0.300	—	mA	1.8V	+85°C	1 MIPS, FOSC = 2 MHz
	0.585	—		3.3V		
DC24	7.76	12.0	mA	3.3V	+85°C	16 MIPS, FOSC = 32 MHz
	—	18.0		3.3V	+125°C	
DC26	1.44	—	mA	1.8V	+85°C	FRC (4 MIPS), FOSC = 8 MHz
	2.71	—		3.3V		
DC30	4.00	28.0	µA	1.8V	+85°C	LPRC (15.5 KIPS), FOSC = 31 kHz
	9.00	55.0		3.3V		
	—	45.0	µA	1.8V	+125°C	
	—	90.0		3.3V		

Note 1: Data in the Typical column is at 3.3V, +25°C, unless otherwise stated.

2: IDD is measured with all peripherals disabled. All I/Os are configured as outputs and set low; PMDx bits are set to '1' and WDT, etc., are all disabled.

TABLE 26-7: DC CHARACTERISTICS: IDLE CURRENT (I_{IDLE})(2)

DC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Conditions**		
Idle Current (IIDLE)						
DC40	0.035	0.080	mA	1.8V	+85°C	0.5 MIPS, FOSC = 1 MHz
	0.077	0.150		3.3V		
	—	0.160	mA	1.8V	+125°C	
	—	0.300		3.3V		
DC42	0.076	—	mA	1.8V	+85°C	1 MIPS, FOSC = 2 MHz
	0.146	—		3.3V		
DC44	2.52	3.20	mA	3.3V	+85°C	16 MIPS, FOSC = 32 MHz
	—	5.00	mA	3.3V	+125°C	
DC46	0.45	—	mA	1.8V	+85°C	FRC (4 MIPS), FOSC = 8 MHz
	0.76	—	mA	3.3V		
DC50	0.87	18.0	µA	1.8V	+85°C	LPRC (15.5 KIPS), FOSC = 31 kHz
	1.55	40.0	µA	3.3V		
	—	27.0	µA	1.8V	+125°C	
	—	50.0	µA	3.3V		

Note 1: Data in the Typical column is at 3.3V, +25°C, unless otherwise stated.

2: IIDLE is measured with all I/Os configured as outputs and set low; PMDx bits are set to '1' and WDT, etc., are all disabled.

26.2 AC Characteristics and Timing Parameters

The information contained in this section defines the PIC24F16KL402 Family AC characteristics and timing parameters.

TABLE 26-16: TEMPERATURE AND VOLTAGE SPECIFICATIONS – AC

AC CHARACTERISTICS	**Standard Operating Conditions: 1.8V to 3.6V** **Operating temperature -40°C ≤ TA ≤ +85°C for Industrial** Operating voltage VDD range as described in **Section 26.1 "DC Characteristics"**.

FIGURE 26-3: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

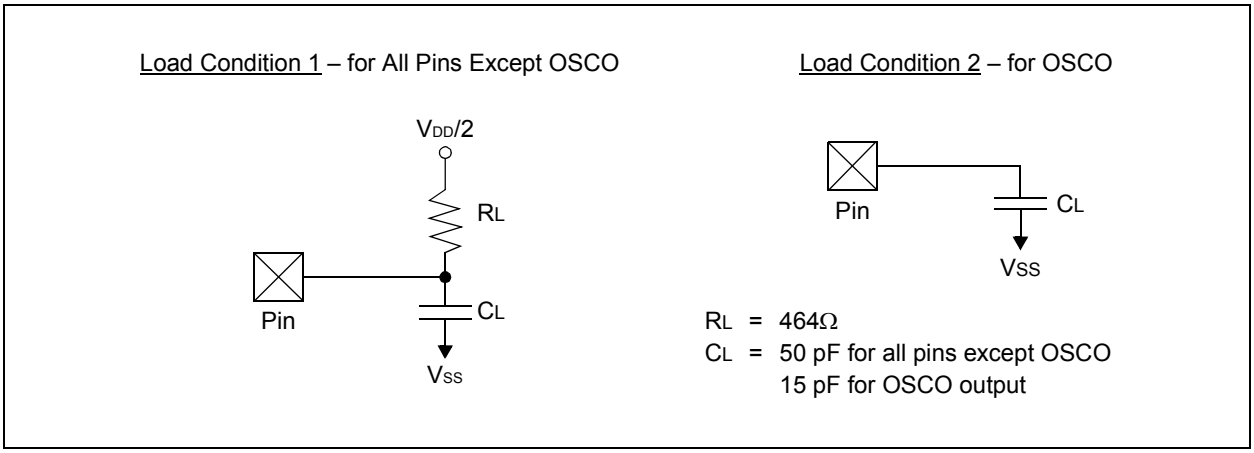


TABLE 26-17: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

Param No.	Symbol	Characteristic	Min	Typ(1)	Max	Units	Conditions
DO50	COSC2	OSCO/CLKO Pin	—	—	15	pF	In XT and HS modes when external clock is used to drive OSCI
DO56	CIO	All I/O Pins and OSCO	—	—	50	pF	EC mode
DO58	CB	SCLx, SDAx	—	—	400	pF	In I^2C™ mode

Note 1: Data in "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

FIGURE 26-4: EXTERNAL CLOCK TIMING

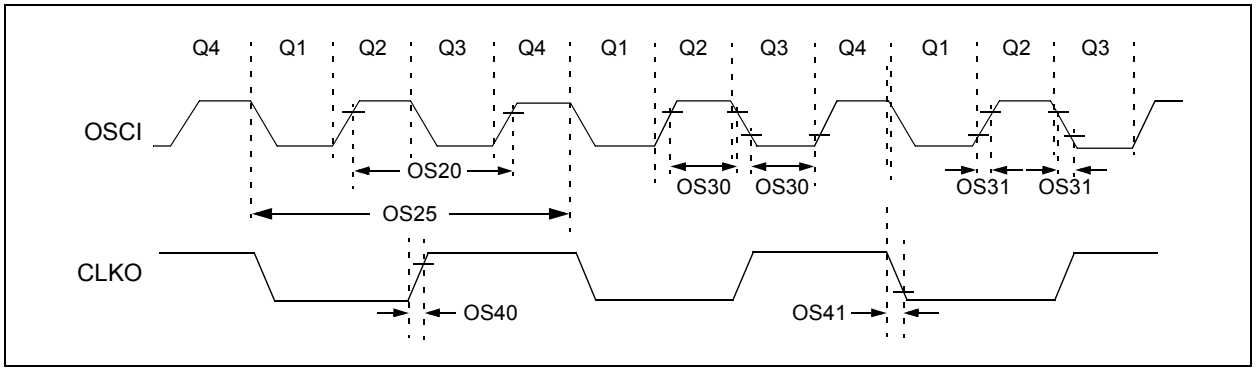


TABLE 26-18: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Sym**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
OS10	FOSC	External CLKI Frequency (External clocks allowed only in EC mode)	DC 4	— —	32 8	MHz MHz	EC ECPLL
		Oscillator Frequency	0.2 4 4 31	— — — —	4 25 8 33	MHz MHz MHz kHz	XT HS HSPLL SOSC
OS20	TOSC	TOSC = 1/FOSC	—	—	—	—	See Parameter OS10 for FOSC value
OS25	TCY	Instruction Cycle Time(2)	62.5	—	DC	ns	
OS30	TosL, TosH	External Clock in (OSCI) High or Low Time	0.45 x TOSC	—	—	ns	EC
OS31	TosR, TosF	External Clock in (OSCI) Rise or Fall Time	—	—	20	ns	EC
OS40	TckR	CLKO Rise Time(3)	—	6	10	ns	
OS41	TckF	CLKO Fall Time(3)	—	6	10	ns	

Note 1: Data in “Typ” column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Instruction cycle period (TCY) equals two times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at “Min.” values with an external clock applied to the OSCI/CLKI pin. When an external clock input is used, the “Max.” cycle time limit is “DC” (no clock) for all devices.

3: Measurements are taken in EC mode. The CLKO signal is measured on the OSCO pin. CLKO is low for the Q1-Q2 period (1/2 TCY) and high for the Q3-Q4 period (1/2 TCY).

TABLE 26-32: I²C™ BUS DATA REQUIREMENTS (SLAVE MODE)

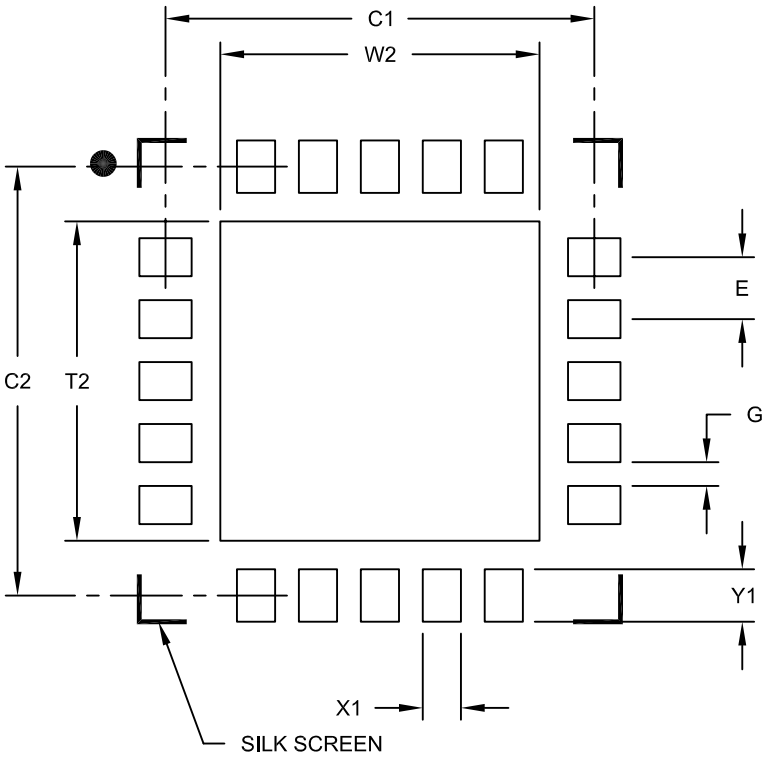
Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
100	THIGH	Clock High Time	100 kHz mode	4.0	—	µs	Must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	—	µs	Must operate at a minimum of 10 MHz
			MSSP module	1.5	—	TCY	
101	TLOW	Clock Low Time	100 kHz mode	4.7	—	µs	Must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	—	µs	Must operate at a minimum of 10 MHz
			MSSP module	1.5	—	TCY	
102	TR	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns	
			400 kHz mode	20 + 0.1 CB	300	ns	CB is specified to be from 10 to 400 pF
103	TF	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns	
			400 kHz mode	20 + 0.1 CB	300	ns	CB is specified to be from 10 to 400 pF
90	TSU:STA	Start Condition Setup Time	100 kHz mode	4.7	—	µs	Only relevant for Repeated Start condition
			400 kHz mode	0.6	—	µs	
91	THD:STA	Start Condition Hold Time	100 kHz mode	4.0	—	µs	After this period, the first clock pulse is generated
			400 kHz mode	0.6	—	µs	
106	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	µs	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	**(Note 2)**
			400 kHz mode	100	—	ns	
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	4.7	—	µs	
			400 kHz mode	0.6	—	µs	
109	TAA	Output Valid from Clock	100 kHz mode	—	3500	ns	**(Note 1)**
			400 kHz mode	—	—	ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	—	µs	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	µs	
D102	CB	Bus Capacitive Loading		—	400	pF	

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCLx to avoid unintended generation of Start or Stop conditions.

2: A Fast mode I²C™ bus device can be used in a Standard mode I²C bus system, but the requirement, TSU:DAT ≥ 250 ns, must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, TR max. + TSU:DAT = 1000 + 250 = 1250 ns (according to the Standard mode I²C bus specification), before the SCLx line is released.

20-Lead Plastic Quad Flat, No Lead Package (MQ) - 5x5 mm Body [QFN]
With 0.40mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			3.35
Optional Center Pad Length	T2			3.35
Contact Pad Spacing	C1		4.50	
Contact Pad Spacing	C2		4.50	
Contact Pad Width (X20)	X1			0.40
Contact Pad Length (X20)	Y1			0.55
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2139A